

TinyLogic UHS Dual 2-Input NAND Gate with Schmitt Trigger Inputs

NC7WZ132

Description

The NC7WZ132 is a dual 2–Input NAND Gate with Schmitt–trigger inputs from **onsemi**'s Ultra High Speed Series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a broad V_{CC} operating range. The device is specified to operate over the 1.65 V to 5.5 V V_{CC} operating range. The inputs and output are high impedance when V_{CC} is 0 V. Inputs tolerate voltages up to 5.5 V independent of V_{CC} operating voltage. Schmitt trigger inputs achieve typically 1 V hysteresis between the positive–going and negative–going input threshold voltage at 5 V V_{CC} .

Features

- Space Saving US8 Surface Mount Package
- MicroPakTM Leadless Package
- Ultra High Speed: $t_{PD} = 3.1$ ns Typ. into 50 pF at 5 V V_{CC}
- High Output Drive: ±24 mA at 3 V V_{CC}
- Broad V_{CC} Operating Range: 1.65 V to 5.5 V
- ullet Matches the Performance of LCX when Operated at 3.3 V V_{CC}
- Power Down High Impedance Inputs / Output
- Overvoltage Tolerant Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry Implemented
- Schmitt Trigger Inputs are Tolerant of Slow Changing Input Signals
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

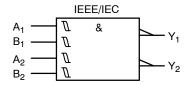


Figure 1. Logic Symbol

MARKING DIAGRAMS



UQFN8 1.6X1.6, 0.5P CASE 523AY





US8 CASE 846AN



T5, WZD2 = Specific Device Code

KK = 2-Digit Lot Run Traceability Code XY = 2-Digit Date Code Format Z = Assembly Plant Code

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 6.

1

Connection Diagram

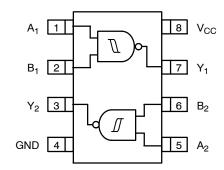
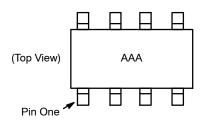


Figure 2. Connection Diagram (Top View)



AAA represents Product Code Top Mark - see ordering code

NOTE: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Figure 3. Pin One Orientation Diagram

PIN DESCRIPTION

Pin Names	Description
A _n , B _n	Inputs
Y _n	Output

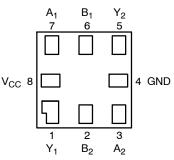


Figure 4. Pad Assignments for MicroPak (Top Thru View)

FUNCTION TABLE $(Y = \overline{AB})$

Inp	Output			
Α	A B			
L	L	Н		
L	Н	Н		
Н	L	Н		
Н	Н	L		

H = HIGH Logic Level

L = LOW Logic Level

ABSOLUTE MAXIMUM RATINGS

Symbol	Parame	Min	Max	Unit	
V _{CC}	Supply Voltage	-0.5	6.5	V	
V _{IN}	DC Input Voltage		-0.5	6.5	V
V _{OUT}	DC Output Voltage		-0.5	6.5	V
I _{IK}	DC Input Diode Current V _{IN} < 0 V		-	-50	mA
I _{OK}	DC Output Diode Current	V _{OUT} < 0 V	-	-50	mA
I _{OUT}	DC Output Current	-	±50	mA	
I _{CC} / I _{GND}	DC V _{CC} / GND Current	-	±100	mA	
T _{STG}	Storage Temperature		-65	+150	°C
TJ	Junction Temperature under Bias		-	150	°C
TL	Junction Lead Temperature (Solde	-	260	°C	
P _D	Power Dissipation in Still Air US8		-	500	mW
		MicroPak-8	-	539	mW

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Paramet	Min	Max	Unit	
V _{CC}	Supply Voltage Operating	1.65	5.5	V	
	Supply Voltage Data Retention	1.5	5.5		
V _{IN}	Input Voltage	0	5.5	V	
V _{OUT}	Output Voltage	0	V _{CC}	V	
T _A	Operating Temperature	-40	+85	°C	
$\theta_{\sf JA}$	Thermal Resistance US8		-	250	°C/W
		MicroPak-8	-	232	°C/W

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. Unused inputs must be held HIGH or LOW. They may not float.

DC ELECTICAL CHARACTERISTICS

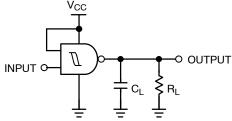
					Т	A = +25°	С	T _A = -40	to +85°C	
Symbol	Parameter	V _{CC} (V)	Co	onditions	Min	Тур	Max	Min	Max	Unit
V_P	Positive Threshold	1.65			T -	0.99	1.4	-	1.4	V
	Voltage	2.3			_	1.39	1.8	-	1.8	1
		3.0			_	1.77	2.2	-	2.2	1
		4.5			_	2.49	3.1	-	3.1	1
		5.5			_	2.96	3.6	-	3.6	1
V _N	Negative Threshold	1.65			0.2	0.53	-	0.2	-	V
	Voltage	2.3	1		0.4	0.78	-	0.4	_	1
		3.0	1		0.6	1.02	-	0.6	_	1
		4.5	1		1.0	1.48	-	1.0	_	1
		5.5	1		1.2	1.76	-	1.2	_	1
V_{H}	Hysteresis Voltage	1.65			0.15	0.46	0.9	0.15	0.9	٧
		2.3			0.25	0.61	1.1	0.25	1.1	1
		3.0			0.4	0.75	1.2	0.4	1.2	1
		4.5			0.6	1.01	1.5	0.6	1.5	1
		5.5			0.7	1.20	1.7	0.7	1.7	1
V _{OH}	HIGH Level Output	1.65	$V_{IN} = V_{IH}$	I _{OH} = -100 μA	1.55	1.65	-	1.55	-	٧
	Voltage 2.3	or V _{IL}		2.2	2.3	-	2.2	-	1	
		3.0			2.9	3.0	-	2.9	-	1
		4.5			4.4	4.5	-	4.4	-	1
		1.65		I _{OH} = -4 mA	1.29	1.52	-	1.29	-	1
		2.3		I _{OH} = -8 mA	1.9	2.15	-	1.9	-	1
		3.0		I _{OH} = -16 mA	2.4	2.80	-	2.4	-	1
		3.0		I _{OH} = -24 mA	2.3	2.68	-	2.3	-	1
		4.5		I _{OH} = -32 mA	3.8	4.20	-	3.8	-	1
V _{OL}	LOW Level Output	1.65	$V_{IN} = V_{IH}$ or V_{IL}	I _{OL} = 100 μA	-	0.0	0.10	-	0.10	٧
	Voltage	2.3	or v _{IL}		_	0.0	0.10	-	0.10	1
		3.0			_	0.0	0.10	-	0.10	1
		4.5			_	0.0	0.10	-	0.10	
		1.65		I _{OL} = 4 mA	_	0.08	0.24	-	0.24	1
		2.3		I _{OL} = 8 mA	_	0.10	0.3	-	0.3	1
		3.0		I _{OL} = 16 mA	_	0.15	0.4	-	0.4	1
		3.0		I _{OL} = 24 mA	_	0.22	0.55	-	0.55	1
		4.5	1	I _{OL} = 32 mA	_	0.22	0.55	-	0.55	1
I _{IN}	Input Leakage Current	1.65 to 5.5	V _{IN} = 5.5	V, GND	_	_	±0.1	-	±1	μΑ
l _{OFF}	Power Off Leakage Current	0.0	V _{IN} or V _{OL}	_{JT} = 5.5 V	-	-	1	-	10	μΑ
I _{CC}	Quiescent Supply Current	1.65 to 5.5	V _{IN} = 5.5 \	/, GND	-	-	1	-	10	μΑ

AC ELECTRICAL CHARACTERISTICS

					T _A = +25°C		T _A = -40	to +85°C	
Symbol	Parameter	V _{CC} (V)	Conditions	Min	Тур	Max	Min	Max	Unit
t_{PLH} , t_{PHL}		1.8 ±0.15	C _L = 15 pF,	-	7,1	13.0	_	13.5	ns
	(Figure 5, 7)	2.5 ±0.2	$R_L = 1 M\Omega$	-	4.5	7.5	_	8.0	
		3.3 ±0.3		-	3.4	5.0	_	5.5	
		5.0 ±0.5	1	-	2.6	3.8	-	4.2	
		3.3 ±0.3	C _L = 50 pF,	-	4.0	5.8	-	6.3	ns
		5.0 ±0.5	$R_L = 500 \Omega$	-	3.1	4.5	_	4.9	
C _{IN}	Input Capacitance	0		-	2.5	-	-	-	pF
C _{PD}	Power Dissipation Capacitance	3.3	(Note 2)	_	15	_	_	-	pF
	(Figure 6)	5.0	1	-	18	-	-	-	

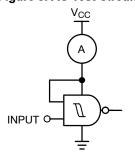
^{2.} C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (see Figure 6) C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC} static)$.

AC Loading and Waveforms



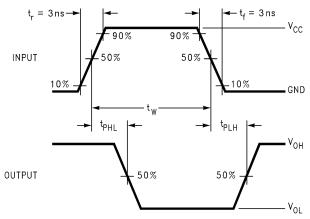
 C_L includes load and stray capacitance Input PRR = 1.0 MHz, t_W = 500 ns $\,$

Figure 5. AC Test Circuit



Input = AC Waveform; $t_r = t_f = 1.8$ ns; PRR = 10 MHz; Duty Cycle = 50%.

Figure 6. I_{CCD} Test Circuit



ORDERING INFORMATION

Order Number	Top Mark	Package	Shipping [†]
NC7WZ132K8X	WZD2	8-Lead US8, JEDEC MO-187, Variation CA 3.1 mm Wide	3000 / Tape & Reel
NC7WZ132L8X	T5	8-Lead MicroPak, 1.6 mm Wide	5000 / Tape & Reel

DISCONTINUED (Note 4)

NC7WZ132K8X-L22236	WZD2	8-Lead US8, JEDEC MO-187, Variation CA 3.1 mm Wide	3000 / Tape & Reel
NC7WZ132L8X-L22185	T5	8-Lead MicroPak, 1.6 mm Wide	5000 / Tape & Reel

tFor information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

3. All packages are lead free per JEDEC: J-STD-020B standard.

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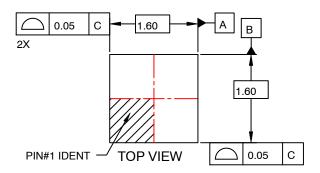


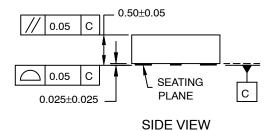
^{4.} **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.

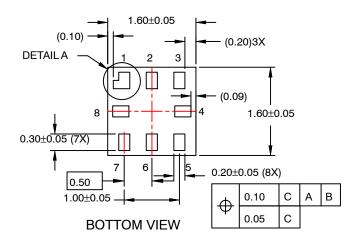


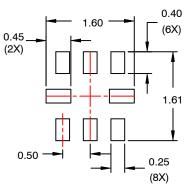
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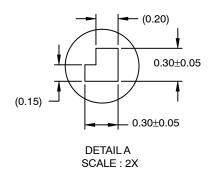




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NOTES:

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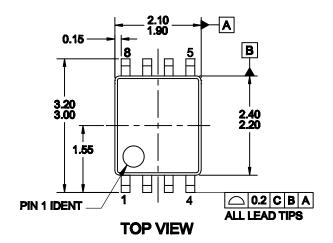
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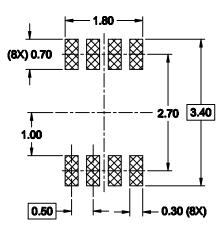
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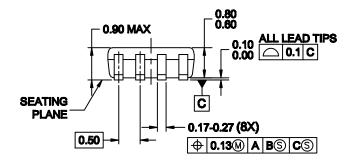
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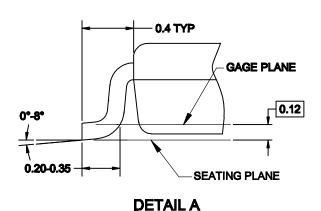
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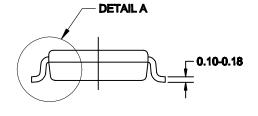


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SIDE VIEW





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